

Title (en)  
HEAT-PEELABLE PRESSURE-SENSITIVE ADHESIVE SHEET AND METHOD OF PROCESSING ADHEREND WITH THE HEAT-PEELABLE PRESSURE-SENSITIVE ADHESIVE SHEET

Title (de)  
WARM ABZIEHBARE HAFTKLEBEFOLIE UND VERFAHREN ZUR VERARBEITUNG VON HAFTGRUND MIT DER WARM ABZIEHBAREN HAFTKLEBEFOLIE

Title (fr)  
FEUILLE AUTOCOLLANTE DETACHABLE A LA CHALEUR ET PROCEDE DE TRAITEMENT DE SURFACE ADHESIVE AVEC LA FEUILLE AUTOCOLLANTE DETACHABLE A LA CHALEUR

Publication  
**EP 1724320 A4 20080827 (EN)**

Application  
**EP 05710670 A 20050218**

Priority  
• JP 2005003069 W 20050218  
• JP 2004068770 A 20040311

Abstract (en)  
[origin: EP1724320A1] Disclosed is a heat-peelable pressure-sensitive adhesive sheet that can prevent the deformation of a pressure-sensitive adhesive layer caused by pressurization, further reduce chipping in grinding and cutting processes, be easily peeled off from a processed article after processing, and can be easily applied to an adhered at ordinary temperature. The heat-peelable pressure-sensitive adhesive sheet includes a substrate, and a heat-expandable pressure-sensitive adhesive layer arranged on or above at least one side of the substrate, the heat-expandable pressure-sensitive adhesive layer containing a foaming agent and having a shear modulus (23°C) in an unfoamed state of 7x 10<sup>6</sup> Pa or more. The adhesive sheet further includes a pressure-sensitive adhesive layer being arranged on or above the heat-expandable pressure-sensitive adhesive layer and having a shear modulus (23°C) of less than 7x 10<sup>6</sup> Pa. The pressure-sensitive adhesive layer arranged on the heat-expandable pressure-sensitive adhesive layer preferably has a thickness of 0.01 to 10 µm.

IPC 8 full level  
**C09J 5/00** (2006.01); **C09J 5/08** (2006.01); **C09J 7/22** (2018.01); **C09J 7/38** (2018.01); **C09J 11/00** (2006.01); **C09J 201/00** (2006.01); **H01G 4/12** (2006.01); **H01G 13/00** (2013.01); **H01L 21/68** (2006.01); **H01L 21/78** (2006.01); **H05K 3/00** (2006.01)

CPC (source: EP KR US)  
**C09J 5/08** (2013.01 - EP KR US); **C09J 7/22** (2017.12 - EP KR US); **C09J 7/38** (2017.12 - EP KR US); **H01L 21/6835** (2013.01 - EP KR US); **H01L 21/6836** (2013.01 - EP KR US); **H05K 3/0058** (2013.01 - KR); **C09J 2203/326** (2013.01 - EP KR US); **C09J 2301/208** (2020.08 - EP KR US); **C09J 2301/502** (2020.08 - EP KR US); **H01L 2221/68327** (2013.01 - EP US); **H01L 2221/6834** (2013.01 - EP KR US); **H01L 2924/19041** (2013.01 - EP US); **H01L 2924/30105** (2013.01 - EP US); **H05K 3/0058** (2013.01 - EP US); **Y10T 428/249984** (2015.04 - EP US); **Y10T 428/26** (2015.01 - EP US); **Y10T 428/28** (2015.01 - EP US); **Y10T 428/2813** (2015.01 - EP US); **Y10T 428/2848** (2015.01 - EP US)

Citation (search report)  
• No further relevant documents disclosed  
• See references of WO 2005087888A1

Cited by  
WO2014067667A1; EP1724319A4; EP1775760A4; EP2366749A1; EP2123728A4; EP1944345A1; US7691225B2; US9868862B2; WO2021022125A1

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